



9 1 & K 3 R Z H U (

Feature

- High Speed Power Switching, Logic Level
- Enhanced Body diode dv/dt capability
- Enhanced Avalanche Ruggedness
- 100% UIS Tested 100% Rg Tested
- Lead Free

| | | |
|------------------|-----|-------------------|
| V _{DS} | 150 | V |
| R _{θJC} | 9 | m ² /K |
| I _{SM} | 0 | A |

Application

- Synchronous Rectification in SMPS
- Hard Switching and High Speed Circuit
- Power Tools
- UPS
- Motor Control

TO262

Electrical Characteristics at T_j X Q O H V V R W K H U Z L V H V S H F L I L H G

Static Characteristics

| Parameter | Symbol | Conditions | Value | | | Unit |
|---------------------------------|---------------------|--|-------|-----|------|------|
| | | | min | Typ | max | |
| Gate Threshold Voltage | V _{GS(th)} | V _{GS} =V _{DS} , I _D =250 mA | 1 | 1.9 | 3 | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} =0V, V _{DS} =150V, T _j | - | - | 1 | μA |
| Gate to Source Leakage Current | I _{GSS} | V _{GS} =±20V, V _{DS} =0V | - | - | ±100 | nA |
| Drain to Source on Resistance | R _{DS(on)} | V _{GS} =10V, I _D =20A | - | 9 | 10.5 | mΩ |
| | | V _{GS} =10V, I _D =4.5A | - | 9.8 | 12.5 | |
| Transconductance | g _{1V} | V _{DS} =5V, I _D =20A | - | 80 | - | S |
| Gate Resistance | R _G | V _{GS} =0V, V _{DS} 2 SH Q I 0 +] | - | 0.7 | - | Ω |

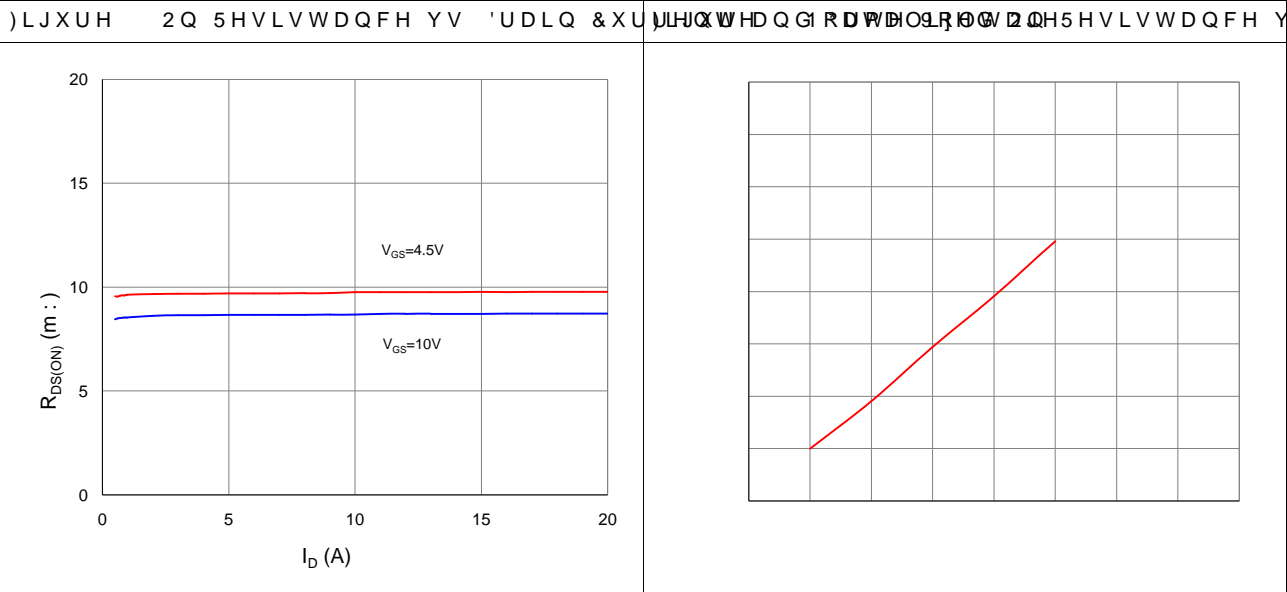
Dynamic Characteristics

| | | | | | | |
|-------------------------------|-----------------------|--|---|------|---|----|
| Input Capacitance | C _{iss} | V _{GS} =0V, V _{DS} 9 I 0 +] | - | 4059 | - | pF |
| Output Capacitance | C _{oss} | V _{GS} =0V, V _{DS} 9 I 0 +] | - | 302 | - | |
| Reverse Transfer Capacitance | C _{rss} | V _{GS} =0V, V _{DS} 9 I 0 +] | - | 11 | - | |
| Total Gate Charge | Q _g (10V) | V _{DD} =75V, I _D =20A, V _{GS} =10V | - | 57 | - | nC |
| Total Gate Charge | Q _g (4.5V) | | - | 26 | - | |
| Gate to Source Charge | Q _{gs} | | - | 12 | - | |
| Gate to Drain (Miller) Charge | Q _{gd} | | - | 10 | - | |
| Turn on Delay Time | t _{d(on)} | V _{DD} =75V, I _D =20A, V _{GS} =10V, R _G =10Ω | - | 20 | - | ns |
| Rise time | t _r | | - | 10 | - | |
| Storage Time | t _{G R II} | | - | 32 | - | |
| Fall Time | t _f | | - | 12 | - | |

Reverse Diode Characteristics

| | | | | | | |
|--------------------------|-----------------|--|---|-----|-----|----|
| Reverse Standoff Voltage | V _{SD} | V _{GS} =0V, I _J =20A | - | 0.9 | 1.2 | V |
| Reverse Recovery Time | t _{rr} | V _R =75V, I _J =20A, dI _J G W R \$ | - | 95 | - | ns |
| Reverse Recovery Charge | Q _{rr} | V _R =75V, I _J =20A, dI _J G W R \$ | - | 285 | - | nC |

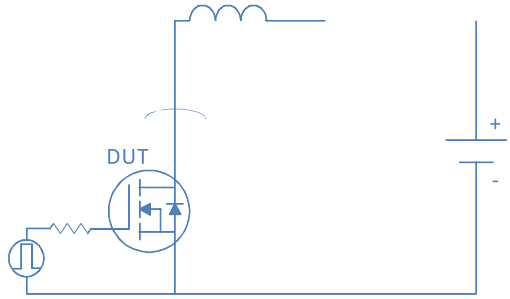
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|---------------------------|--|
| , QGXFWLYH VZLWFKLQJ 7HVW | |
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| Gate Charge Test | |
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|---|--|
| 8FODPSHG , QGXFWLYH 6ZLWFKLQJ 8,6 7HVW | |
|  | |

| | |
|---------------------|--|
| Diode Recovery Test | |
| | |

TO-262, 3 leads

Unit: mm

| DIM | MILLIMETERS |
|-----|-------------|
| A | 9.98±0.2 |
| a | 7.4±0.4 |
| B | 4.5±0.2 |
| b1 | 1.3±0.05 |
| b2 | 2.4±0.2 |
| H | 23.9±0.3 |
| h | 3.1±0.2 |
| h1 | 9.16±0.2 |
| h2 | 13.2±0.2 |
| L | 0.5±0.1 |
| l1 | 1.3±0.1 |
| l2 | 0.8±0.1 |
| N | 2.45±0.1 |